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PATENT ABSTRACTS OF JAPAN

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(71) Applicant: SUMITOMO ELECTRIC

(72) Inventor: FUKUI HARUYO

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NAKAYAMA AKIRA SETOYAMA MAKOTO

YOSHIOKA TAKESHI

YAMAGATA KAZUO

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(54) ULTRA-THIN FILM **LAMINATE**

(57) Abstract:

PURPOSE: To improve the wear resistance and oxidation resistance of the surface of a substrate by alternately repetitively laminating thin films of two kinds of Ti-Al-N compds. varying in compsn. on the surface of the substrate.

CONSTITUTION: The thin film 3 which consists of carbides, nitride and carbonitrides of group IVa, Va and VIa metals in periodic table and has a thickness of 0.05 to 5µm is formed by an ion plating method by a vacuum arc discharge on the surface of the hard base material 2, such as cutting tip, drill or end mill. consisting of a WC-base sintered hard a way, cermet, ceramics or highspeed steel, Two kinds of the compds. A, B expressed by TixAl1xN (where $0 \le X < 0.5$) and TiyAll-yN

(where 0.5<y≤1) are alternately laminated in many layers on the surface of the thin-film layer 3 by setting the sum λof the thickness t1, t2 of these compds. as a repetitive lamination period of 0.5 to 20nm. The thin films 1 having the total thickness of 0.5 to 10µm are thus formed. The wear resistance and oxidation resistance of the substrate 1 are greatly improved by the alternately laminated thin films of the Ti-Al-N alloy.

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